

# Description

The FMD-4204S is a fast recovery diode of 400 V / 20 A. The maximum  $t_{rr}$  of 50 ns is realized by optimizing a life-time control.

#### **Features**

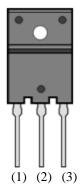
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

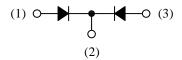
# Applications

- PFC Circuit
- Inverter Circuit

#### Package

TO3PF-3L





- (1) Anode
- (2) Cathode
- (3) Anode

Not to scale

## **Absolute Maximum Ratings**

Unless	otherwise	specified.	$T_A = 25 \ ^\circ C$	
Chiebb	0000000000	specifica,	IA 20 C	•

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage <sup>(1)</sup>	V <sub>RSM</sub>		400	V
Repetitive Peak Reverse Voltage <sup>(1)</sup>	V <sub>RM</sub>		400	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	20	А
Surge Forward Current <sup>(1)</sup>	I <sub>FSM</sub>	Half cycle sine wave, positive side, 10 ms, 1 shot	100	А
I <sup>2</sup> t Limiting Value <sup>(1)</sup>	I <sup>2</sup> t	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	A <sup>2</sup> s
Junction Temperature	$T_J$		-40 to 150	°C
Storage Temperature	T <sub>STG</sub>		-40 to 150	°C

# **Electrical Characteristics**

5 °C.	-				
Symbol	Conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	$T_J = 25 \ ^{\circ}C, \ I_F = 10 \ A$	—	_	1.4	V
	$T_J = 100 \ ^{\circ}C, I_F = 10 \ A$		0.97		V
I <sub>R</sub>	$V_R = V_{RM}$			20	μA
$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 \ ^\circ C$	_		200	μA
t <sub>rr1</sub>	$I_F = I_{RP} = 500 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$	_		50	ns
t <sub>rr2</sub>	$I_{F} = 500 \text{ mA},$ $I_{RP} = 1000 \text{ mA},$ 75%  recovery point, $T_{J} = 25 \text{ °C}$	_		30	ns
R <sub>th(J-C)</sub>				2.5	°C/W
	V <sub>F</sub> I <sub>R</sub> H·I <sub>R</sub> t <sub>rr1</sub>	$\begin{tabular}{ c c c c c } \hline Symbol & Conditions \\ \hline V_F & $T_J = 25 \ ^\circ C, \ I_F = 10 \ A$ \\ \hline T_J = 100 \ ^\circ C, \ I_F = 10 \ A$ \\ \hline T_J = 100 \ ^\circ C, \ I_F = 10 \ A$ \\ \hline I_R & V_R = V_{RM} \\ \hline H \cdot I_R & V_R = V_{RM}, \ T_J = 150 \ ^\circ C$ \\ \hline I_F = I_{RP} = 500 \ mA, \\ g0\% \ recovery \ point, \\ T_J = 25 \ ^\circ C$ \\ \hline I_F = 500 \ mA, \\ I_{RP} = 1000 \ mA, \\ 75\% \ recovery \ point, \\ T_J = 25 \ ^\circ C$ \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c } \hline Symbol & Conditions & Min. \\ \hline V_F & $T_J = 25 \ ^\circ C, \ I_F = 10 \ A $ & $$ \\ \hline $T_J = 100 \ ^\circ C, \ I_F = 10 \ A $ & $$ \\ \hline $T_J = 100 \ ^\circ C, \ I_F = 10 \ A $ & $$ \\ \hline $I_R $ & $V_R = V_{RM} $ & $$ \\ \hline $H^+I_R $ & $V_R = V_{RM}, \ T_J = 150 \ ^\circ C $ & $$ \\ \hline $H^+I_R $ & $V_R = V_{RM}, \ T_J = 150 \ ^\circ C $ & $$ \\ \hline $H^+I_R $ & $V_R = V_{RM}, \ T_J = 150 \ ^\circ C $ & $$ \\ \hline $I_F = I_{RP} = 500 \ mA, $$ \\ $90\%$ recovery point, $$ & $$ \\ \hline $T_J = 25 \ ^\circ C $ $ \\ \hline $I_F = 1000 \ mA, $$ \\ $T_J = 25 \ ^\circ C $ $ \\ \hline $T_J = 25 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1000 \ ^\circ C $ \\ \hline $T_J = 1$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

# **Mechanical Characteristics**

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.686	_	0.882	N·m
Package Weight			6.5		g

<sup>&</sup>lt;sup>(1)</sup> Specifies a value per chip; the FMD-4204S consists of two chips.

<sup>&</sup>lt;sup>(2)</sup> Refers to thermal resistance between junction and the case. The case temperature is measured at the backside near the screw hole.

#### **Derating Curves**

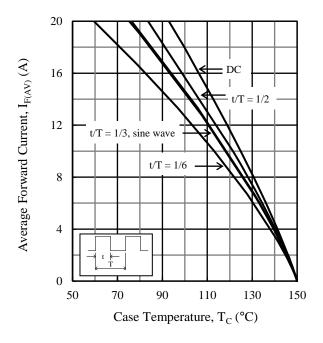


Figure 1.  $I_{F(AV)}$  vs.  $T_C$  ( $T_J = 150 \ ^\circ C$ ,  $V_R = 0 \ V$ )

**Characteristic Curves** 

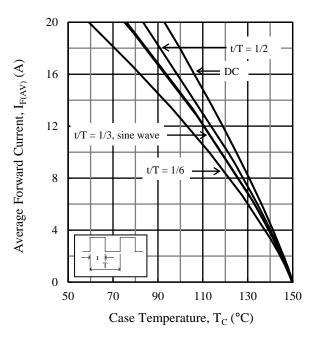
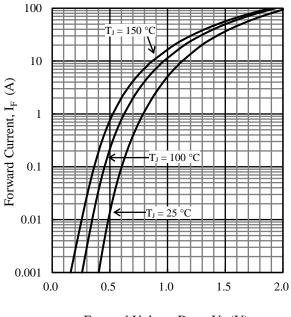
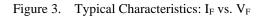
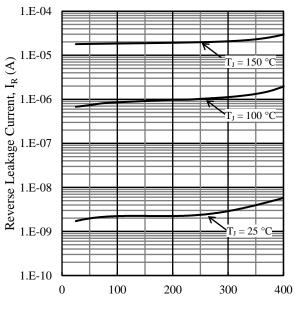


Figure 2.  $I_{F(AV)}$  vs.  $T_C$  ( $T_J = 150 \ ^{\circ}C$ ,  $V_R = 400 \ V$ )

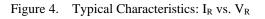


Forward Voltage Drop,  $V_F(V)$ 





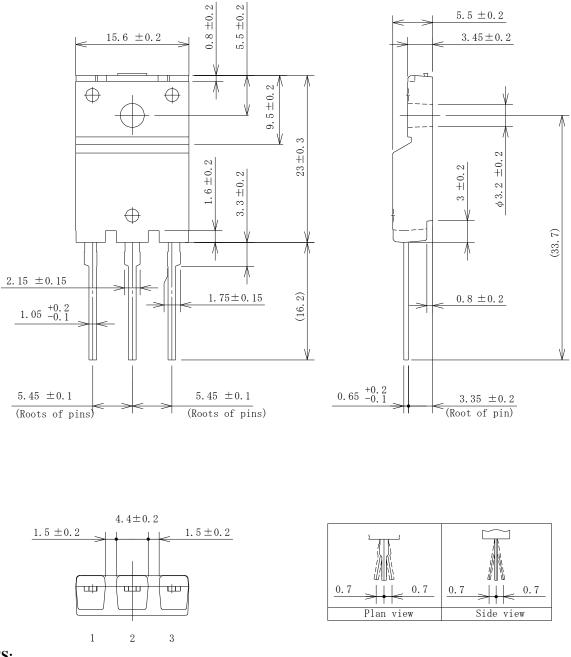
Reverse Voltage,  $V_R(V)$ 



# FMD-4204S-DSE Rev.1.1SANKEN ELECTRIC CO., LTD.Sep. 27, 2022https://www.sanken-ele.co.jp/en© SANKEN ELECTRIC CO., LTD. 2020

#### **Physical Dimensions**

#### • TO3PF-3L



#### **NOTES:**

- Dimensions in millimeters
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits: Flow: 260  $^{\circ}C$  / 10 s, 1 time
  - Soldering Iron: 350 °C / 3.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

## **Marking Diagram**

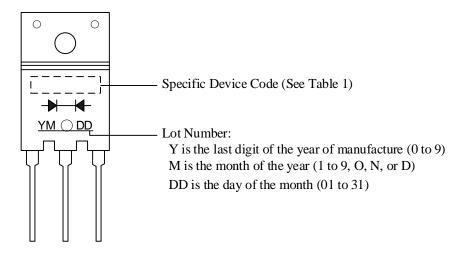


Table 1. Specific Device Code

Specific Device Code	Part Number		
D4204	FMD-4204S		

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